

IEC SYSTEM FOR MUTUAL RECOGNITION OF TEST CERTIFICATES FOR ELECTRICAL EQUIPMENT (IECEE) CB SCHEME

SYSTEME CEI D'ACCEPTATION MUTUELLE DE CERTIFICATS D'ESSAIS DES EQUIPEMENTS ELECTRIQUES (IECEE) METHODE OC

CB TEST CERTIFICATE

CERTIFICAT D'ESSAI OC

Product
Produit

Notebook PC

Name and address of the applicant
Nom et adresse du demandeur

ASUSTEK COMPUTER INC
4TH FL 150 LI-TE RD PEITOU TAIPEI 112 TAIWAN

Name and address of the manufacturer
Nom et adresse du fabricant

ASUSTEK COMPUTER INC
4TH FL 150 LI-TE RD PEITOU TAIPEI 112 TAIWAN

Name and address of the factory
Nom et adresse de l'usine

TECH-COM (SHANGHAI) COMPUTER CO. LTD
68 SANZHUANG RD SONGJIANG EXPORT PROCESSING ZONE SHANGHAI 201613 CHINA

Note: When more than one factory, please report on page 2
Note: Lorsque il y plus d'une usine, veuillez utiliser la 2^{ème} page

Ratings and principal characteristics
Valeurs nominales et caractéristiques principales

Additional Information on page 2
19.5Vdc, 16.9A

Trademark (if any)
Marque de fabrique (si elle existe)

ASUS



Type of Manufacturer's Testing Laboratories used
Type de programme du laboratoire d'essais constructeur

Model / Type Ref.
Ref. De type

G800xxxxxxxxxxxxxxxxxxxx, GX800xxxxxxxxxxxxxxxxxxxx
See Page 2

Additional information (if necessary may also be reported on page 2)
Les informations complémentaires (si nécessaire,, peuvent être indiqués sur la 2^{ème} page

Additional Information on page 2

A sample of the product was tested and found to be in conformity with
Un échantillon de ce produit a été essayé et a été considéré conforme à la

IEC 60950-1(ed.2), IEC 60950-1(ed.2);am1, IEC 60950-1(ed.2);am2

As shown in the Test Report Ref. No. which forms part of this Certificate
Comme indiqué dans le Rapport d'essais numéro de référence qui constitue partie de ce Certificat

ASL16062330-001 issued on 2016-09-29

This CB Test Certificate is issued by the National Certification Body
Ce Certificat d'essai OC est établi par l'Organisme **National de Certification**



- UL (US), 333 Pfingsten Rd IL 60062, Northbrook, USA
- UL (Demko), Borupvang 5A DK-2750 Ballerup, DENMARK
- UL (JP), Marunouchi Trust Tower Main Building 6F, 1-8-3 Marunouchi, Chiyoda-ku, Tokyo 100-0005, JAPAN
- UL (CA), 7 Underwriters Road, Toronto, M1R 3B4 Ontario, CANADA

For full legal entity names see www.ul.com/ncbnames

Date: 2016-10-06
Original Issue Date: 2016-07-25

Signature:

Jan-Erik Storgaard



Model Details:

G800xyyyyyyyyyyyyyyy.GX800xyyyyyyyyyyyyyyy (x = A-Z, a-z, - or blank; y =0-9, A-Z, a-z, - or blank, for marketing purpose and no impact safety related construction and critical components)

Factories:

DIGITEK (CHONGQING) LTD
B01 SEC C AIRPORT FUNCTION ZONELIANGLU CUNTAN FREE TRADE PORT AREA YUBEI DISTRICT
CHONGQING
CHINA

TECH-FRONT (CHONGQING) COMPUTER CO LTD
18 ZONGBAO RD SHAPINGBA DISTRICT CHONGQING
CHINA

COMPAL INFORMATION TECHNOLOGY (KUNSHAN) CO LTD
58 1ST AVE A ZONE KUNSHAN COMPREHENSIVE FREE TRADE ZONE KUNSHAN JIANGSU
CHINA

COTEK ELECTRONICS (SUZHOU) CO LTD
288 MAYUN RD. NEW DISTRICT. SUZHOU. JIANGSU. 215011
CHINA

WISTRON INFOCOMM (KUNSHAN) CO LTD
FIRST AVE KUNSHAN INTEGRATED FREE TRADE ZONE KUNSHAN JIANGSU
CHINA

WISTRON INFOCOMM (CHONGQING) CO LTD
18-9 BAOHONG AVENUE WANGJIA SUB-DISTRICT YUBEI DISTRICT CHONGQING 401120
CHINA

Additional Information:

Additionally evaluated to EN 60950-1:2006 /A11:2009 /A1:2010 /A12:2011/ A2:2013.

National Difference specified in the CB Test Report.

The original report was modified to include the following changes/additions:

1. Update National Difference.
2. Add model.
3. Add motherboard.
4. Add optional docking with approval Liquid-cooling module.

Additional information (if necessary)

Information complémentaire (si nécessaire)



- UL (US), 333 Pfingsten Rd IL 60062, Northbrook, USA
- UL (Demko), Borupvang 5A DK-2750 Ballerup, DENMARK
- UL (JP), Marunouchi Trust Tower Main Building 6F, 1-8-3 Marunouchi, Chiyoda-ku, Tokyo 100-0005, JAPAN
- UL (CA), 7 Underwriters Road, Toronto, M1R 3B4 Ontario, CANADA

For full legal entity names see www.ul.com/ncbnames

Date: 2016-10-06
Original Issue Date: 2016-07-25

Signature:

Jan-Erik Storgaard